EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

White Chip LED With Right Angle Lens

12-215/T1D-ANPHY/3C

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-Free.
- The product itself will remain within RoHS compliant version

Descriptions

- The 12-215 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

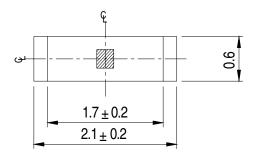
Device Selection Guide

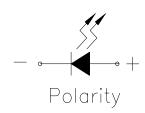
Don't Mo	Chip		Lang Colon	
Part No.	Material	Emitted Color	Lens Color	
12-215/T1D-ANPHY/3C	InGaN	Pure White	Yellow Diffused	

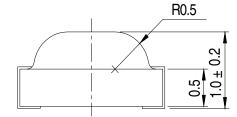


Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 1 of 11

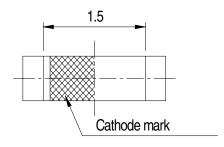
Package Outline Dimensions

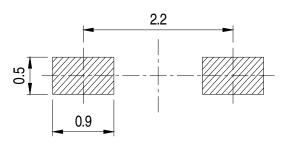






For reflow soldering (Propose)





Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Device No.: SZDSE-125-T03

http://www.everlight.com

Prepared date: 06-Mar-2006

Rev.1

Page: 2 of 11

Prepared by: xunzhi hu

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge(HBM)	ESD	150	V	
Power Dissipation	Pd	110	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA	
Soldering Temperature	Tsol		Soldering: $260 ^{\circ}\text{C}$ for 10sec. oldering: $350 ^{\circ}\text{C}$ for 3sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	28.5		72.0	mcd	IF=5mA
Viewing Angle	2 0 1/2		140		deg	I _F =5mA
Forward Voltage	VF	2.70		3.15	V	I _F =5mA
Reverse Current	Ir			50	μ A	V _R =5V

Bin Range Of Luminous Intensity & Forward Voltage

	9		•			
	Symbol	Bin Code	Min.	Max.	Unit	Condition
	T	N	28.5	45.0	1	IF=5mA
	Iv	P	45.0	72.0	mcd	
	VF	15	2.70	2.85		
		16	2.85	3.00	V	I _F =5mA
		17	3.00	3.15		

Notes:

1. Tolerance of Luminous Intensity ±10%

2.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 11



Chromaticity Coordinates Specifications for Bin Grading

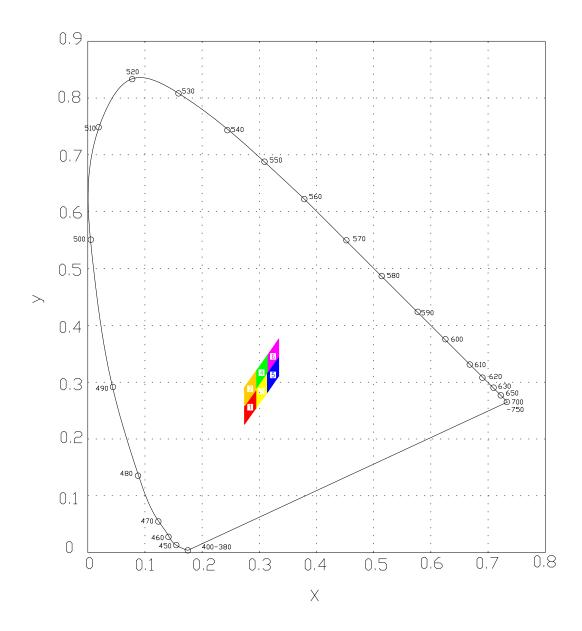
Groups	Bin Code	CIE_x	CIE_y	Condition
	1	0.274	0.226	
		0.274	0.258	
		0.294	0.286	
		0.294	0.254	
		0.274	0.258	
	2	0.274	0.291	
	2	0.294	0.319	
		0.294	0.286	
		0.294	0.254	
	3	0.294	0.286	
		0.314	0.315	
A		0.314	0.282	T- 5 A
А	4	0.294	0.286	IF=5mA
		0.294	0.319	
	4	0.314	0.347	
		0.314	0.315	
	5	0.314	0.282	
		0.314	0.315	
		0.334	0.343	
		0.334	0.311	
		0.314	0.315	
	6	0.314	0.347	
	6	0.334	0.376	
		0.334	0.343	

Notes:

- 1.The C.I.E. 1931 chromaticity diagram (Tolerance ± 0.01).
- 2. The products are sensitive to static electricity and care must be fully taken when handling products.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 11

CIE Chromaticity Diagram



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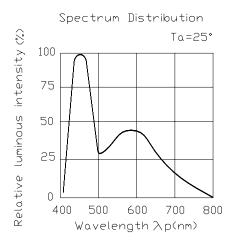
Prepared date: 06-Mar-2006

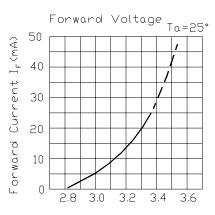
Rev.1

Page: 5 of 11

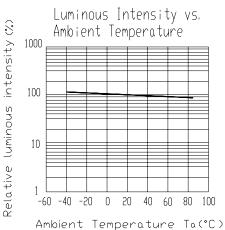
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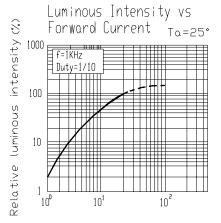
Typical Electro-Optical Characteristics Curves



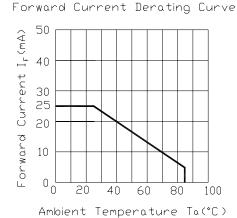


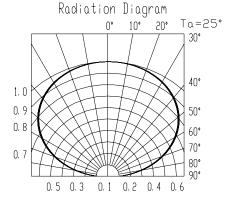
Forward Voltage(V_P)-volts





Forward Current I_F (mA)



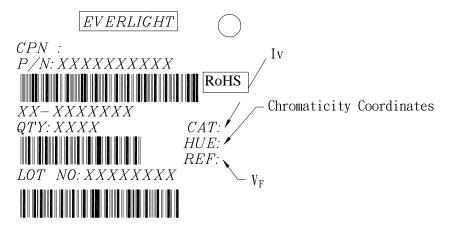


Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 6 of 11

Device No.: SZDSE-125-T03 Prepared date: 06-Mar-2006 Prepared by: xunzhi hu

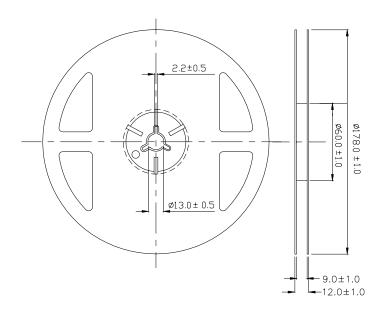
Label explanation

CAT: Luminous Intensity Rank HUE: Chromaticity Coordinates REF: Forward Voltage Rank



MADE IN TAIWAN

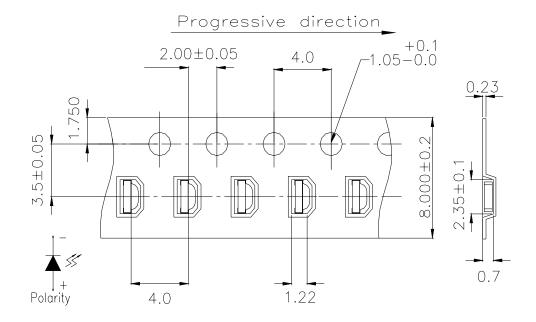
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

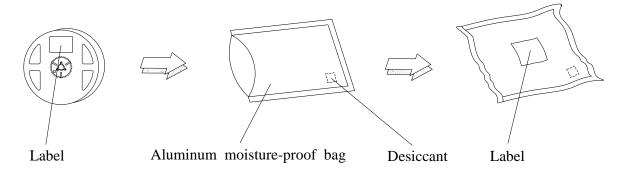
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 7 of 11

Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Prepared date: 06-Mar-2006

Rev.1

Page: 8 of 11

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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 520 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 11

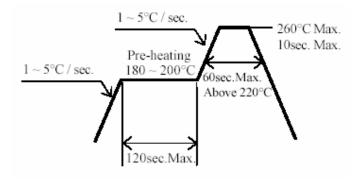
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 10 of 11

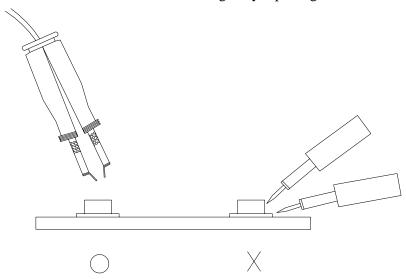


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

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Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 11 of 11